

Operating Manual: Twelve-SCR General Purpose Gate Firing Board FCOG1200 Revisions F or K

Introduction

This manual describes the salient features and specifications of the FCOG1200 firing board, including typical firing circuit signal waveforms and a checkout procedure.

Product Description

1.0 Application

The firing board responds to a voltage or current delay angle command signal (SIG HI) to produce two delayed sets of six isolated, 60°-spaced high-current SCR gate firing pulses, each set is separated by 30° of each other for a total of 12 outputs for firing parallel or series connected 12-pulse DC converters or AC controllers. The twelve gate pulses are precisely spaced at 30° as required to eliminate the 5th and 7th harmonics of the mains current.

1.1 Advantages of twelve pulse rectification.

When used as a DC converter, the FCOG1200 automatically adapts to the sequence of the AC mains voltage (whether a-b-c or a-c-b) and to the 30° phase shift (whether +30° or -30°) between the two groups of three phase voltages applied to the converter input.

Twelve pulse rectification provides the benefits of reduced harmonic current into the input transformer and reduced ripple current in the DC output (ripple frequency is doubled to 720 Hz and ripple driving voltage is halved). The result is improved power quality of the AC mains current and reduced size of the DC filter choke.

2.0 ASIC-Based Firing Circuit

All firing circuit logic is contained in two custom 24-pin ASIC (U3 and U4). Additional detail on the firing circuit theory is contained in a separate engineering society paper¹.

3.0 Board Mounted Connectors

The firing board is connectorized to simplify maintenance and troubleshooting.

3.1. Gate/Cathode Connectors

The SCR gate/cathode interface is provided by 8-position Mate-N-Lok[™] vertical connectors² J1 through J4, and mating plus P1 through P4. The connectors are keyed to prevent incorrect installation or reversal of the mating plugs. Plugs P1 and P3 access the gates and cathodes of the six SCRs having load connected cathodes when the SCRs are arranged in the in-line AC controller or DC bridge converter configurations. Similarly, plugs P2 and P4 access the gates and cathodes of the six SCRs having line connected cathodes.

3.2. Control Signal Connector

The firing board connects to the gate delay command and inhibit controls through a 15-position Mate-N-Lok[™] connector J6. This connector also accesses the 24Vac board power, the 30VDC rectified input board power/ or board power, and the regulated +12/+5 VDC outputs. The 24Vac and 30VDC connections permit the board to be powered from an external source. With 24Vac applied (24VA minimum), approximately 10 Watts of DC power are available from J6 to power lamps or control relays.

¹ Bourbeau, F. J., "Phase Control Thyristor Firing Circuit: Theory and Applications", Power Quality '89, Long Beach, California. ² Right-Angle or Horizontal connectors are not available in this board.

3.3. Phase Reference Test Signal Input Connector

For low-power testing, users may connect 2 sets of low-level (5 V_{PP}) three-phase test reference signals, each set of three-phases must be shifted by 30°, to the first six positions of an eight-position MTA header J7. This allows the board checkout to proceed without connection to high voltage power. Users may alternatively connect off-board phase reference resistors at J7; this is a useful option if the six phase references may not be derived from the SCRs. Positions 7 and 8 provide respectively a connection to circuit common and to an unregulated 15VDC supply (10mA max) that could be optionally used to drive external circuitry.

3.4. Frequency Selection Connector

A 3-position header, J5, is used in conjunction with RN4³ and capacitors C23 and C29 to select between 50 Hz and 60 Hz operation. In 60Hz operation, RN4 is $120K\Omega$, C23 and C26 are 0.27μ F and R36 is connected in parallel with R35. IN 50Hz operation RN4 is $150K\Omega$, C23 and C26 are 0.33μ F and J5 removes R36 from the circuit in order to maintain TP2 at 5.0VDC.

3.5. Control Input Voltage

The power supply on the FCOG1200 board operates from a customer-supplied external 24Vac, 24VA, single phase power source. The power supply produces unregulated 30VDC, and regulated 12VDC and 5VDC.

4.0 Gate Delay Command

The delay command signal, SIG HI, may be configured either as a 0.9-5.9VDC, 0-5VDC, or 4 to 20 mA current command (with a maximum upper limit of 50mA). The default SIG HI range is 0.9 to 5.9 Volts as R25 is 249K Ω . The input resistance presented to the delay command signal SIG HI is determined by resistor R40. This value is selected as 10.0 k Ω when the control signal is designated as a control voltage. As an option, if R25 is 150K Ω , the input signal range of SIG HI will be 0-5Vdc.

When the gate delay command is a current signal, R40 is selected to give a 5VDC level at the maximum desired delay command signal current (without exceeding the maximum 50mA limit).

5.0 Gate Inhibits

SCR gating is inhibited by pulling either the instant inhibit, $\overline{I_1}$ or soft inhibit, $\overline{I_2}$ signal to ground. These signals are located at J6 pin 4 and J6 pin 12, respectively.

The instant inhibit signal $\overline{I_1}$ is normally pulled to ground through resistor R41 (1.50 k Ω). The user typically connects the $\overline{I_1}$ signal to +12 VDC to enable firing. This arrangement ensures that SCR gating is inhibited if plug P6 is inadvertently disconnected. A jumper may be installed between pins 4 and 6 of P6 to hold $\overline{I_1}$ at +12 VDC at all times in applications where the instant inhibit is not needed.

The soft inhibit signal $\overline{I_2}$ is normally pulled to +12 VDC through resistor R42 (1.50 k Ω). As a default, the user then grounds $\overline{I_2}$ to soft-stop SCR firing. In this mode, the delay angle is ramped from the setpoint value determined by SIG HI to the largest angle possible, after which firing is completely inhibited. This is termed the soft-stop shutdown mode. When user opens the connection at $\overline{I_2}$, gating is enabled with the delay angle set to the maximum limit. The delay angle then ramps to the value determined by SIG HI. The soft-stop and soft-start time constants are independently configurable via two timing resistors (R22 and R39 respectively) and a capacitor (C4).

As an <u>option</u> the soft inhibit signal $\overline{I_2}$ may be tied to common through resistor R37 (1.50 k Ω). In this case resistor R42 is omitted and the $\overline{I_2}$ signal is toggled exactly as the $\overline{I_1}$ signal.

³ RN4, C23, and C29 may be placed in a component-socket for ease of installation.

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6.0 Phase Loss Inhibit

The FCOG1200's phase loss circuit instantly inhibits SCR gating if the mains voltage phases are grossly imbalanced or, in the extreme case, if one or more phase voltages are missing. This feature also eliminates the possibility of erratic response associated with voltage imbalance or transients when the two sets of three-phase mains are initially connected to the SCRs. After any phase loss fault, the board soft-starts when the fault is cleared. The phase loss circuit is also activated when the six-phase power is initially applied to the CSRs. Gating is inhibited until the power supply voltage has stabilized.

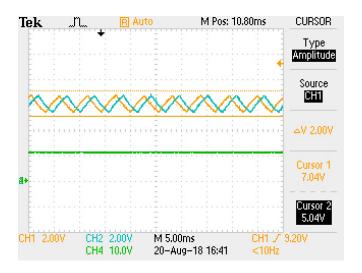


Figure 1. Phase Loss Circuit Signals – No Phase Loss⁴

- 1. Y resulting phase summing signal, TP16
- 2. X resulting phase summing signal, TP15
- 3. PL Signal, U6 P1

Notes:

Channels:

- The Phase-Loss LED (PD1) is off.
- The two yellow markers represent the upper and lower phase-loss thresholds at U6 pin 9 and pin 10 respectively.
- Both TP15 and TP16 are well within the upper and lower phase-loss thresholds.

⁴ All waveforms contained in this document were obtained with the FCOG1200 revision K firing board connected to 240Vac, 60 Hz, balanced 6-phase power via sockets 2, 5, and 8 of plugs P2 and P4. The time base of each screenshot has been calibrated for phase measurements as noted at 60 Hz. All component designations refer to drawing E640, revision F or K.

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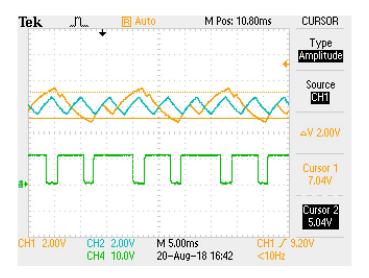


Figure 2. Phase Loss Circuit Signals – Phase Loss

- 1. Y resulting phase summing signal. TP16
- 2. X resulting phase summing signal, TP15
- 3. PL Signal, U6 P1

Notes:

Channels:

- The Phase-Loss LED (PD1) is ON.
- The two yellow markers represent the upper and lower phase-loss thresholds at U6 pin 9 and pin 10 respectively.
- TP15 is not within the upper and lower phase-loss thresholds.

7.0 **Phase Reference Shift Selection**

A first-order RC lowpass filter (formed by RN4 and capacitors C17-22) shifts the mains phase references by 0° (for controller applications) or by 30° lagging (for converter applications). For 30° lagging references, the previously referenced capacitors are 0.033 µF film capacitors and RN4 is a 120 k Ω , 14-position, isolated DIP resistor network.

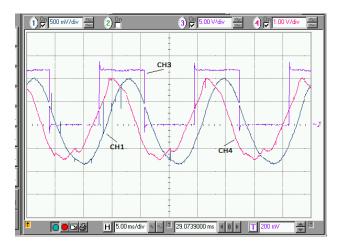


Figure 3. Thirty-degree shifted phase references, Phase Ax Channel:

- 4. Phase Ax Line-to-Neutral Voltage
 - 1. Attenuated and Filtered Mains Voltage at RN4-14
 - 3. Reference Comparator Output, TP5

For 0° references, 0.01 μ F film capacitors may be installed with RN4 = 120 k Ω . Alternatively, 0.033 μ F film capacitors may be used with a 33 k Ω resistor network installed at RN4 for 0° shifted references. This is an optimal scheme if the same firing board may be used to fire controllers or converters, as the user may then simply change RN4 (typically supplied in a socket in this case) to achieve the required phase shift.

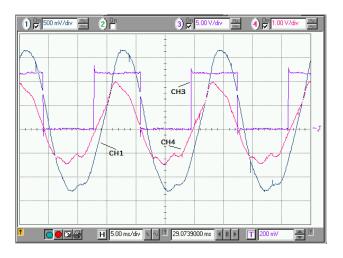


Figure 4. Zero-degree shifted phase references, Phase Ax Channel: 4. Phase A Line-to-Neutral Voltage

- 1. Attenuated and Filtered Mains Voltage at RN4-14
- 3. Reference Comparator Output, TP5

8.0 Gate Pulse Generation

Two-position jumpers JU1and JU2 enable gate pulse profile selection. With JU1 and JU2 installed, the pulse profile is two 30°-wide bursts, each with an initial hard-firing gate pulse and followed by sustaining "picket fence" pulses. With these jumpers omitted, the gate pulse profile changes to a single 120°-wide burst with the same hard-firing initial pulse. The initial hard-firing pulse and sustaining pulses ensure continuous SCR conduction over the required period.

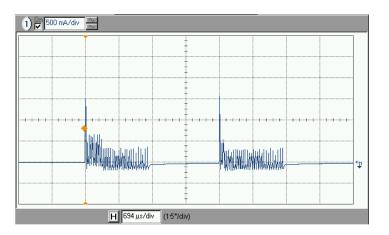


Figure 5. 2-30° Gate Pulse Profile (Into 1Ω)⁵

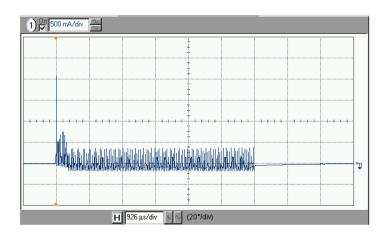


Figure 6. 120° Gate Pulse Profile (Into 1Ω).

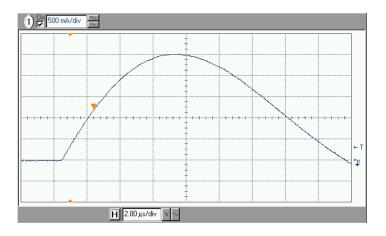


Figure 7. Initial pulse profile detail (Into 1Ω).

Each gate logic signal drives a primary winding of twelve isolated pulse modules. The primary winding of each pulse transformer is also connected to a current-limiting resistor (R1-R3 and R4-R6) and a speed-up capacitor (C11-C13 and C14-C16); this provides an initial hard-firing gate pulse followed by sustaining, lower amplitude picket fence pulses.

Each pulse module consists of a 2:1 ratio pulse transformer tested for 3500 V_{RMS} isolation, two secondary diodes, noise-suppression resistors across the primary and across the gate drive

 $^{^{5}}$ Current waveforms obtained using a Pearson model 2877 current transformer with 4 primary turns. The current transformer is terminated by the scope's 1.0M Ω input impedance.

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output, and a fusible link in series with the output. Each pulse module is potted in a silicone insulating material.

The DDFO1200 (delay determinator fiber optic) is a version of the FCOG1200 with fiber optic outputs replacing the pulse transformers. Twelve FO1024 modules are installed which feature Avago HFBR-1412Z fiber optic transmitters in lieu of the EP1024 modules. The transmitters feature ST (bayonet) style connectors, operate at 820 nm and are directly compatible with the MVTB series of medium voltage trigger boards. Each module has an LED to indicate that the fiber optic transmitter is operational. Please specify this configuration on your ordering documents or contact Enerpro for additional information.

9.0 Balancing Circuits

Ideally, the phase shift transformer that powers the two 6-Pulse Thyristor bridges, which make up a 12-Pulse converter, provides two sets of three phase voltages equal in amplitude and phase shifted by 30°. In practice, transformer imperfections cause a small open circuit voltage unbalance, impedance unbalance, and a slight deviation from 30° phase shift. As a result, individual bridge currents of the parallel 12-Pulse converter become unbalanced, the 5th and 7th harmonics of the ac mains current are not completely canceled, and a dc ripple voltage a six time the mains frequency appears on the converter output.

The upgraded (REV F and REV K) FCOG1200 firing board provides three means of adjusting the nominal 30° group delay in order to optimize the system performance. This optimization will allow the user to balance the bridge currents, thereby minimizing the ac current harmonics and dc ripple voltage. The three methods are outlined below:

9.1 Manual Balance: On-Board Trimpot Adjustment

This, the simplest means of control, is the default configuration of the FCOG1200 firing board. For on-board trimpot manual adjustment, the FCOG1200 is configured as follows:

R11	Installed (25.0kΩ pot.)	R51	Installed (100kΩ)
R48	Omit	U12	Omit
R49	Omit	JU4	Omit
R50	Installed (100kΩ)	JU5	Omit

With this control method you will optimize the 12-Pulse system for operation at a particular current level. This will ensure that the system provides balanced six phase current and minimum THD at the optimized current level. However, as the dc current diverges from this optimum level, the transformer and firing board imperfections will cause the phase currents to diverge. This, in turn, will cause an increased THD level on the ac mains.

Adjustment is performed by setting the dc output current at the desired level. Once you have reached the desired level, monitor the input currents to the individual bridges and the dc output current. Adjust the on-board trimpot, R11, as required to obtain balanced bridge input currents (if required, adjust the command signal as necessary to maintain the desired dc output current).

9.2 On-Board Auto-Balance Control

This control method provides active control of the 30° group delay in order to optimize the circuit at all dc output currents. Implementation of this control method requires two customer-provided

current feedback signals, labeled "x" and "y" in Figure 8. These current feedback signals may be derived from the bridge ac input currents, as shown, or from the individual bridge output currents. The feedback signals should be of equal amplitude, approximately 1.0 - 5.0Vdc. The feedback signals are then applied to J6 pins 14 and 15 on the FCOG1200 board and the FCOG1200 board is configured as follows⁶:

R11	Omit
R48	Installed (10.0kΩ)
R49	Installed (10.0kΩ)
R50	Installed (100kΩ)

 R51
 Installed (100kΩ)

 U12
 Installed (MC14070BCP)

 JU4
 Omit

 JU5
 Omit

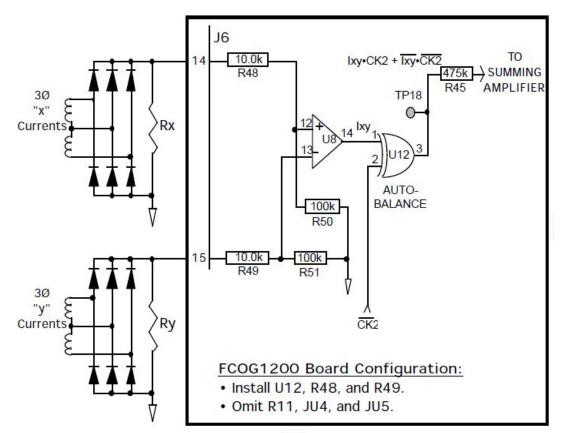


Figure 8. On-board Auto-Balance Circuit

This circuit operates by injecting a high frequency (6^*f_{mains}) square wave into the Voltage Controlled Oscillator (VCO) summing amplifier. This square wave serves to increase the delay angle (α) of the high current bridge while reducing the delay angle of the low current bridge. These delay angle adjustments will actively equalize the bridge input currents thereby ensuring optimum system performance.

9.3 External Auto-Balance Control

The FCOG1200 Revision F and K firing board can also be controlled by an external auto-balance circuit. This circuit will perform the same functions as the on-board auto-balance circuit but could

⁶ The FCOG1200 board can be supplied with this configuration. Please request that the boards be configured for "on-board auto-balance" when ordering.

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also provide regulation (closed-loop control). In this mode the FCOG1200 board is configured as follows⁷:

R11	Omit	R51	Omit
R48	Installed (10.0kΩ)	U12	Omit
R49	Jumper	JU4	Installed
R50	Omit	JU5	Installed

The high frequency (6*f_{mains}) output of the external auto-balance circuit should be connected to J6 pin 14 of the FCOG1200 board. If desired, the external circuit can obtain CK2 and NOT (CK2) signals at J6 pins 15 and 13, respectively.

10.0 **Electrical Specifications**

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Table 1. General Specifications.				
AC mains voltage 600 Vac				
Pulse transformer hipot	3500 Vac (60 seconds)			
Operating temperature range	-5 C to 85 C			
Board ac supply voltage	28 Vac (24 Vac nominal)			
12 V regulator output current	5 mA (30 VDC supply)			
5 V reference output current	5 mA (30 VDC supply)			
Auxiliary control power output from 24 Vac/30 VDC	10 W			
Delay angle range	$10^\circ \le \alpha \le 170^\circ$			
Electrical Charac				
Delay angle command signal, SIG HI	Voltage: 0-5, 0.85-5.85, 0-10, 0-2 V			
	Current: 4-20 mA			
	Or per customer specification			
Delay angle reference phase shift	0° or -30° (application-specific)			
Control signal isolation from ground	653 kΩ (For higher isolation, use transformer			
	coupled phase references)			
	Galvanic isolation provided by pulse			
	transformers and control power transformer			
Gate delay steady-state transfer function	Delay angle decreases as SIG HI increases			
Gate delay dynamic transfer function bandwidth	-3 dB at 119 Hz, phase shift -45° at 68 Hz			
Gate drive phase balance	±1° (max)			
Delay angle variance	$\Delta(\alpha)/\Delta(f) = 0.2^{\circ}/Hz$			
Mains voltage distortion effect	Firing not affected by zero crossing; phase			
	reference filter attenuation is 12.8 dB relative			
	to fundamental at 5 th harmonic			
Lock acquisition time	30 ms (typ)			
Soft-start/stop time (independently configurable)	0.05 – 20.0 s (typical)			
Phase rotation effect	None			
Phase loss inhibit	Automatic			
Power-on inhibit	Automatic			
Instant/soft inhibit/enable inputs	Dry contact			
SCR gate pulse waveform (jumper selectable)	120° burst or			
	2-30° bursts, 30° spaced. Select via JU1 &			
	JU2.			
Gate pulse burst frequency	384 times line frequency			
Gate pulse width, 50 Hz	20-22 µs			
Gate pulse width, 60 Hz	24-26 µs			
Initial gate pulse open circuit voltage	15 V (30 VDC supply)			
Sustaining gate pulse open circuit voltage	7.0 V (30 VDC supply)			
Peak gate drive short circuit current	1.5 A (30 VDC supply, 1.0 Ω gate load)			
Sustaining gate drive short circuit current	0.5 A (30 VDC supply, 1.0 Ω gate load)			
Short-circuit gate drive current rise time	1.0 A/μs (30 VDC supply, 1.0 Ω gate load)			
Board dimensions	194 x 191 x 34 mm (L x W x D)			
Minimum creepage distance to ac mains	13 mm			
Conformal coating	per MIL-1-46058, Type UR			

 $^{^7}$ The FCOG1200 board can be supplied with this configuration. Please request that the boards be configured for "on-board autobalance" when ordering.

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Table 2. Electrical and Mechanical Specifications.

The electrical specifications of the general purpose firing board are summarized in the table below. Part
numbers refer to drawing E640 (REV F or REV K)

numbers refer to drawing E640 (REV F or REV K)				
Characteristic	Performance Requirement	Supporting Information		
1.Line voltage reference	Resistive attenuators and 60°	Reference signals automatically		
sensing	phase shift single pole filters.	interchanged for negative phase		
2. PLL reference signal phasing	Application:	sequence.		
w.r.t. mains line-to-neutral	Application.			
voltage:				
a. Ref. signals in phase with	a. AC controllers with high			
mains voltage.	power factor loads.			
b. Ref. signals lagging mains	b. Converters of AC Controllers			
voltage by 30°,	with lo power factor loads.			
3. SCR gate waveform.	Pulse Profile:			
a. Mode 1	120° burst of 128 pulses (23,040Hz carrier)	JU1 and JU2 must be omitted		
b. Mode 2	2-30° bursts of 32 pulses (23.040Hz carrier)	JU1 and JU2 must be installed		
4. Input control signal.	0.9V to 5.9VDC control signal.	Option 1: 0-5VDC control signal.		
	Load resistance is 8.33 $K\Omega$	Option 2: A shunt resistance		
		(R40) across input signal can be selected for mA control.		
5. Control signal isolation from	653 ΚΩ	Produced by the six 2.0 M Ω		
ground.		mains voltage sense resistors, internal to PM4-6 and PM9-12.		
6. Gate delay steady-state	An increase in command	α_{max} and α_{min} change equally		
transfer function.	voltage produces a proportional	with changes in R _{BIAS} (R32) and		
	decrease in gate delay angle α .	$(\alpha_{max} - \alpha_{min})$ changes with		
7 Cata dalay dynamia transfer	Attenuation= -3dB at 119Hz	respect to R _{SPAN} (R31).		
7. Gate delay dynamic transfer function bandwidth	Phase Shift= -45° at 68Hz	Frequency response can be modified by changing summing		
		amplifier parameters.		
8. Gate delay angle balance.	Gate pulses for same polarity	Assumes balanced line-to-line		
,	SCRs are displaced by 120°	mains voltage. Balance		
	±1.0°, Gate pulses for opposite	determined by reference		
	polarity SCRs are displaced by	comparator offset and		
	180° ± 1.0°.	attenuator/filter component		
0 Effect of free success		tolerances.		
9. Effect of frequency.	Da/Df= 1.5°/Hz. For 50 Hz	Due to Type I PLL and 60° phase shift low pass reference		
	operation, compensate by removing R36 and changing	filters.		
	RN4 to 150 K Ω .			
10. Effect of phase rotation.	None	SCR gating sequence matches		
-		mains voltage sequence.		
11. Effect of mains voltage	1. Unaffected by false reference	1. No PLL response to short-		
distortion.	voltage zero crossing.	time false reference logic states.		
	2. 60° filter attenuates 5 th	2. Reference filter attenuates		
	harmonic by 12.8 dB relative to	5 th , 7 th , 11 th , etc. harmonics from		
12. Lock acquisition time.	fundamental. Approximately 29 seconds	6-pulse SCR switching. Gating is inhibited for 20ms or		
12. LUCK acquisition time.	Approximately 29 seconds	longer at power-on. Inhibit		
		period depends on Soft-Start		
		time constant.		
13. Soft-Start	Gating commences at α_{max} and	Soft-Start time constant is set by		
13. SUIL-SIAIL				
13. 3011-31a11	exponentially decays to the	C4 and R22.		
	exponentially decays to the commanded delay when	T=(1.5K + R22)(C4)(0.579)		
13. 301-3tart	exponentially decays to the	-		

14.Soft-Stop		Soft-Stop time constant is set by C4 and R39. T=(R39)(C4)(1.84) T=ms, R= K Ω , C= μ F R39 ≥ 1.0 K Ω
15. Phase loss inhibit.	Gate-delay angle ramps to α _{max} before being inhibited when (NOT[I2]) is grounded.	Gating resumes with $\alpha = \alpha_{max}$ as the delay angle ramps to the commanded delay angle as determined by the Soft-Start time constant.
16. Power-on inhibit.	Loss of a mains voltage or severe phase unbalance causes gate inhibit.	Same delay angle response as with phase loss inhibit.
17. Instantaneous inhibit.	Phase loss inhibit circuit is activated at power-on.	Gate is inhibited if P6 is removed.
18. SCR gate current individual pulse width.	Opening the connection of <i1> (P6-4) to +12V instantly in inhibits SCR gating. Closing connection of <i1> to +12V instantly enables SCR gating.</i1></i1>	Gate current ON and OFF times vary with gate delay angle because of 360Hz FM in the VCO output.
19. Peak gate drive open circuit voltage.	T _{ON} and T _{OFF} vary from 15µs to 28µs.	With a 30VDC supply voltage
20. Peak gate drive short circuit current.	14V	Measured with a 30VDC supply voltage and a 1.0Ω load resistor
21.Gate drive current rise-time (short circuit)	1.8A	Measured with a $30VDC$ supply voltage and a 1.0Ω load resistor
	0.5A in 0.5 µs	

11.0 Installation and Checkout

The following procedure should be followed to ensure proper operation prior to the application of mains power to the SCR unit.

11.1. <u>Ensure that the power is off.</u> Wire plugs, P2 and P4, with mains voltage connected to sockets 2, 5, and 8. Insert plug P2 into connector J2 and plug P4 into connector J4.

11.2. Connect the appropriate power to J6:

11.2..1. 24Vac: J6 position 1 and J9 position 2.

11.2..2. 30VDC: J6 positon 3 for (+30) and position 8 or 11 (COM).

11.3. Install plug P6 with a 0-5VDC or 0.9-5.9VDC SIG HI delay command signal, signal common, and instant/soft inhibit controls wired to the plug.

11.4. Energize the FCOG1200 board with the appropriate voltage on J6, with 24 Vac or 30 VDC.

11.5. Verify the presence of regulated +12 VDC \pm 5% at J6 position 6 and regulated +5 VDC \pm 5% at J6 position 7 with a multi-meter.

11.6. Energize the mains voltage, this will remove the phase loss condition from the FCOG1200 board. Verify that the PLL is in lock and the mains voltages are balanced by noting the Phase Loss LED is not lit.

11.7. Verify that the DC level of the VCO control voltage at TP2 is approximately 5.0 VDC. This voltage is factory-set by selection of the VCO timing select resistor.

11.8. Determine the PLL gate delay angle from the pulse width of the A-phase detector output at TP7 for the X-bride and at TP12 for the Y-bridge. Calibrate the oscilloscope time-base at 20°/div (0.926 ms/div at 60 Hz). Read the gate delay angle directly from the TP7 and TP12 pulse off the horizontal axis.

11.9. Vary the delay command voltage from 0 VDC to 5.0 VDC or from 0.9V to 5.9VDC. Observe that the gate delay angle at TP7 and TP12 has the desired minimum and maximum values.

11.10. To increase the minimum and maximum gate delay angles by an equal amount, increase the value of the delay BIAS resistor, R32. To increase the difference between the maximum and minimum delay angles, reduce the value of the delay SPAN resistor, R31.

A.0 Appendix: Theory of Operation

A.1 Phase References

The phase references for the phase locked loop (PLL) delay angle generator are derived from the two sets of 30° phase shifted three phase ac supply voltages that power the two SCR circuits. These voltages are sensed at the gate trigger transformers⁸ on the firing board. The supply voltages are processed by resistive attenuators, low pass filters, phasor addition circuitry, and differential comparators.

The time constant of the low pass filter is selected to give a lagging phase shift of $q = 60^{\circ}$ at the 60 Hz operating frequency. A phasor addition technique adds a 60° phase lead, giving an adjusted reference delay phase shift at 60 Hz of 60° - $60^{\circ} = 0^{\circ}$.

The six attenuated and filtered reference signals are applied to six voltage comparators. These comparators are contained on LSI device U5 (EP1016). Additional circuitry is contained in U5 to modify the comparator input signals to give correct reference phasing when the sequence of the ac power is reversed.

A.2 Six Phase: Phase Locked Loop (PLL)

Three of the reference comparator outputs, designated as A_x , B_x , and C_x in Figure A.1, are applied to three EX-OR phase detectors in LSI device U3 (EP1014). The other three reference comparator outputs, designated as Ay, By, and Cy, are applied to the three EX-OR phase detectors in LSI device U4 (EP1015). The other six inputs to the phase detectors are produced by ring counters in LSI devices U3 and U4, as described below.

The outputs of the six phase detectors in U3 and U4 are summed with six $100k\Omega$ resistors and applied to the inverting input of the summing amplifier. The output of the summing amplifier sets the frequency of the voltage controlled oscillator (VCO). This clock signal is designated as CK1 in Figure 1. The clock frequency is 384 (6 x 64) times the mains frequency when the PLL is in lock. A ÷ 64 binary counter (BC) operates on CK1 to produce a second clock signal CK2 which is six times the mains frequency. A ÷6 ring counter (RC1) outputs the three delayed phase references for the EX-OR phase detector in U3.

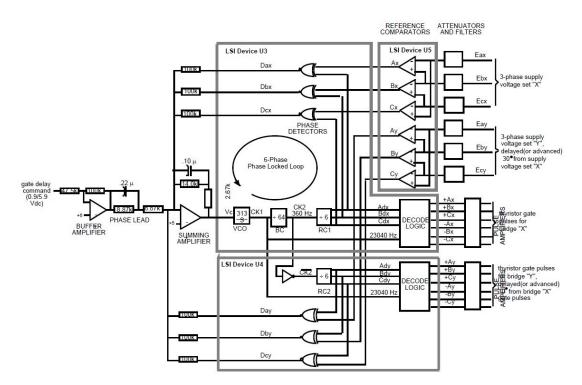
An Inverter in LSI U4 produces the inverted clock signal NOT(CK2). This clock toggles a second ring counter RC2 to produce the three delayed reference outputs A_{dy} , B_{dy} , and C_{dy} . Because of the clock signal inversion, these references are shifted in phase by 30° from the corresponding delayed reference signals A_{dx} , B_{dx} , and C_{dx} in LSI device U3.

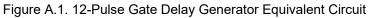
The mains voltage references, Ax through Cy, are input into EX-NOR gates to produce the phase detector outputs, Dax through Dcy.

The six phase detector outputs and the buffered delay command input must sum to a constant value if the VCO frequency is to remain a fixed multiple of the mains frequency. Therefore, an increase in the buffered delay command input must be accompanied by a corresponding decrease in the average value of the summed phase detector outputs. Thus the dc level change is produced by a proportional change in the delay angle between the mains frequency and the delayed reference. A proportional relationship is enforced between the mains voltage phase reference and the delayed phase references.

⁸ The value of this internal resistor (R) can be determined by the pulse module part number: All pulse modules used are EP1024-x, where x=0 (R=OMIT), x = 1 (R=2.0MΩ, used at E>240Vac), x=2 (R = 511kΩ, used at 120Vac <E < 240Vac), and x = 3 (R = 200kΩ, used at E < 120Vac).

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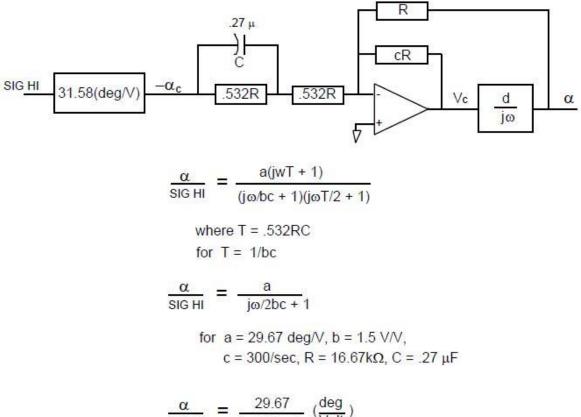


A.3 Steady-State Transfer Function

The 0.9Vdc/5.9Vdc gate delay command signal is amplified by a factor of -100/47.5 = 2.11 in the buffer amplifier and applied through a pair of $8.87k\Omega$ resistors to the inverting input of the summing amplifier. The output voltage of the summing amplifier is at a constant average level (in the range of 4.5Vdc to 5.5Vdc) when the PLL is in lock. This enforces the requirement that a change in the output of the buffer amplifier be matched by a proportional and opposite change in the average voltage at the outputs of the six EX-OR phase detectors. The factor of proportionality is the ratio of the control signal input resistance (= 2 x 8.87k\Omega = 17.74k\Omega) to the effective value of the resistance's that sum the phase detector outputs (= $100k\Omega/6 = 16.67k\Omega$). Since a 180° change in the phase angle between the mains voltage phase references A_x through C_y and the delayed phase references A_{dx} through C_{dy} corresponds to a 12Vdc change in each EX-OR output, a change in the delay angle command, Δ SIG HI, results in a gate delay angle change of A α , of

 $\Delta a / \Delta SIG HI = (100/47.5) \times (16.7/17.74) \times (180/12) = 29.67 ^{\circ} / V$

A.4 Firing Board Frequency Response



$$\frac{\alpha}{\text{SIG HI}} = \frac{23.07}{j\omega/939 + 1} \left(\frac{\alpha \text{SIG HI}}{\text{Volt}}\right)$$

Figure A.2. Phase Loss Circuit Signals – No Phase Loss

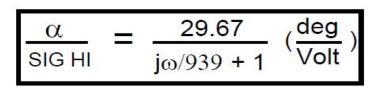
Note that figure A.2 shows the simplified block diagram of the PLL gate delay determinator.

$$\frac{\alpha}{\text{SIG HI}} = \frac{a(jwT + 1)}{(j\omega/bc + 1)(j\omegaT/2 + 1)}$$

Where "T" is the lead-lag time constant, "a" is scale factor relating gate delay angle to delay command voltage, "c" is the summing amplifier gain, and "b" is the VCO integration constant. Choosing T = 1/bc for pole-zero cancellation results in a simple lag transfer of

$$\frac{\alpha}{\text{SIG HI}} = \frac{a}{j\omega/2bc+1}$$

For b = 1.5V/V and c = 300/sec.



This transfer function has 45° phase shift and -3db attenuation at w = 939 rad/sec (150Hz).

A.5 Gate Command Decoding

The delayed reference signals A_{dx} , B_{dx} , C_{dx} and A_{dy} , B_{dy} , C_{dy} are applied to decoding circuits in LSI devices U3 (EP1014) and U4 (EP1015) to produce the required 12 gate pulse signals. These signals are precisely spaced by 30° and shifted in phase from the line-to-line voltage zero crossings by phase angle a. The gate pulse profile is a "picket fence" of 128 pulses having a 50% duty cycle and a pulse width of 26 ms⁹. This profile is produced by decoding circuitry which ANDs the 23,040 Hz clock CK1 with the 60Hz outputs of the ring counters in U3 and U4. Since the gate pulse carrier is phased-locked to the mains frequency, the first pulse in the gate pulse train always has a full 26 us pulse width.

A.6 Gate Pulse Amplifier

Circuitry shown in drawing E640 consisting of transistor arrays U10 and U11, resistors R1 through R8, capacitors C11 through C16, and gate pulse isolation modules PM1 through PM12 amplify and shape the Thyristor gate current pulses. Each pulse module consists of a 2:1 ratio pulse transformer tested for 3500 V_{rms} isolation, two secondary diodes, noise-suppression resistors across the primary and across the gate drive output, and a fuse in series with the output.

⁹ An optional pulse pattern is available consisting of: two 32 pulse, 6.5 ms wide, 6.5 ms spaced gate pulse trains.